

TE Internal #: 1473005-1 Double Data Rate (DDR), 5.2 mm [.205 in] Stack Height, Right Angle Module Orientation, 200 Position, .6 mm [.024 in] Centerline, SO **DIMM Sockets**

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DRAM Type: Double Data Rate (DDR)

Stack Height: 5.2 mm [.205 in]

Module Orientation: Right Angle

Number of Positions: 200

Centerline (Pitch): .6 mm [.024 in]

All DDR2 SO DIMM Sockets (28)

Features

Product Type Features

Connector & Contact Terminates To	Printed Circuit Board						
Connector System	Cable-to-Board						
DRAM Type	Double Data Rate (DDR)						
Configuration Features							
Number of Bays	2						
Number of Keys	1						
Number of Rows	2						
Module Orientation	Right Angle						
Number of Positions	200						
Electrical Characteristics							
DRAM Voltage	2.5 V						
Signal Characteristics							
SGRAM Voltage	2.5 V						

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Body Features

Latch Plating Material	Tin					
Latch Material	Stainless Steel					
Module Key Type	SGRAM					
Ejector Type	Locking					
Ejector Location	Both Ends					
Connector Profile	Standard					
Contact Features						
Contact Current Rating (Max)	.5 A					
Memory Socket Type	Memory Card					
Contact Base Material	Copper Alloy					
PCB Contact Termination Area Plating Material	Gold Flash					
Contact Mating Area Plating Material	Gold Flash					
Termination Features						
Insertion Style	Cam-In					
Termination Method to PCB	Surface Mount					

Mechanical Attachment

	05/15/2025 0/
Circuit Application	Power
Operation/Application	
Operating Temperature Range	-55 – 85 °C[-67 – 185 °F]
Usage Conditions	
Row-to-Row Spacing	6.2 mm[.244 in]
Stack Height	5.2 mm[.205 in]
Dimensions	
Centerline (Pitch)	.6 mm[.024 in]
Housing Color	Black
Housing Material	High Temperature Thermoplastic
Housing Features	
PCB Mount Retention	With
Mating Alignment Type	Standard Keying
PCB Mount Retention Type	Solder Peg
Connector Mounting Type	Board Mount

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Industry Standards				
UL Flammability Rating	UL 94V-0			
Packaging Features				
Packaging Quantity	20			
Packaging Method	Semi-Hard Tray Assembly			
Product Compliance For compliance documentation, visit the product page on TE.com> EU RoHS Directive 2011/65/EU	Compliant			
EU ELV Directive 2000/53/EC	Compliant			
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold			
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC			
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free			
Solder Process Canability	Reflow solder capable to 215°C			

Reflow solder capable to 245°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

Double Data Rate (DDR), 5.2 mm [.205 in] Stack Height, Right Angle Module Orientation, 200 Position, .6 mm [.024 in] Centerline, SO DIMM Sockets





Customers Also Bought



RN 0805 1K0 0.01% 10PPM 1K RL	CRGH0603 1% 47R 0.2W	ASSY,HDR,VERT,GWT,BOSSED,DUAL ROW,EP2.5	FSN-12A-7
TE Part #AKA876N0085057A000 617 EXTENSION, SPEEDTEC	TE Part #6431-BCE-S-025-000 25cmH2O Assymetric Diff Sensor		

Documents

Product Drawings SEMI HARD TRAY DDR SOCKET 200P

English

CAD Files

Customer View Model

ENG_CVM_CVM_1473005-1_J1.2d_dxf.zip

English

3D PDF

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3D

Customer View Model ENG_CVM_CVM_1473005-1_J1.3d_igs.zip English

Customer View Model

ENG_CVM_CVM_1473005-1_J1.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications Product Specification

English